



MJ N-Channel Super Trench II Power MOSFET

Description

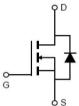
The series of devices uses Super Trench II technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of R_{DS(ON)} and Qg. This device is ideal for high-frequency switching and synchronous rectification.

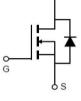
General Features

- ♦ Vps =120V.lp =90A $R_{DS(ON)}$ <7.7m Ω @ V_{GS} =10V
- ◆ Excellent gate charge x R_{DS(on)} product(FOM)
- ◆ Very low on-resistance R_{DS(on)}
- ◆ 175°C operating temperature
- ◆ Pb-free lead plating

Application

- ◆ DC/DC Converter
- ◆ Ideal for high-frequency switching and synchronous rectification







Schematic Diagram

TO-220

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJXP080N12	MJXP080N12	TO-220	-	-	-

Absolute Maximum Ratings (Tc=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	120	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	90	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	64	А
Pulsed Drain Current (Note 1)	Ідм	360	А
Maximum Power Dissipation	Po	140	W
Derating factor		0.93	W/°C
Single pulse avalanche energy (Note 4)	Eas	352	mJ
Operating Junction and Storage Temperature Range	Тл ,Тѕтс	-55 To 175	°C

Thermal Characteristic





Electrical Characteristics (Tc=25℃ unless otherwise noted)

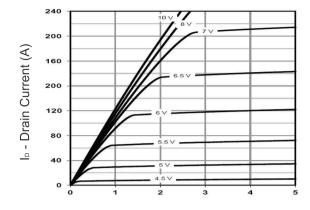
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			1			
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	120	-	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =120V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	_	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250μA	2.0	3.0	4.0	V
Drain Course On Chata Basistanas	D	Vgs=10V, Ip=45A	-	7.7	8.0	mΩ
Drain-Source On-State Resistance	Rds(on)	V _{GS} =10V, I _D =45A	-	7.5	8.0	mΩ
Forward Transconductance	grs	V _{DS} =5V,I _D =45A	-	55	-	S
Dynamic Characteristics (Note 3)						
Input Capacitance	Clss		-	3715	-	PF
Output Capacitance	Coss	V _{DS} =60V,V _{GS} =0V F=1.0MHz	-	275	-	PF
Reverse Transfer Capacitance	Crss		-	18	-	PF
Switching Characteristics (Note 3)			'			
Turn-on Delay Time	t _{d(on)}		-	20	-	nS
Turn-on Rise Time	tr	V _{DD} =60V,I _D =45A	-	16	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =1.6Ω	-	45	-	nS
Turn-Off Fall Time	tr		_	12	-	nS
Total Gate Charge	Qg		_	58	-	nC
Gate-Source Charge	Qgs	V _{DS} =60V,I _D =45A V _{GS} =10V	_	21	-	nC
Gate-Drain Charge	Q _{gd}	. 55 . 61	_	14.5	_	nC
Drain-Source Diode Characteristics						<u> </u>
Diode Forward Voltage (Note 2)	Vsp	V _{GS} =0V,I _S =45A	_	-	1.2	V
Diode Forward Current	Is		_	_	90	А
	trr		_	65	_	nS
Reverse Recovery Time	"	TJ=25°C, IF=90A				

Notes:

- $\textcircled{1} \ \mathsf{Repetitive} \ \mathsf{Rating:} \ \mathsf{Pulse} \ \mathsf{width} \ \mathsf{limited} \ \mathsf{by} \ \mathsf{maximum} \ \mathsf{junction} \ \mathsf{temperature}.$
- ② Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 3 Guaranteed by design, not subject to production
- 4 EAS condition : T_j=25°C,V_{DD}=50V,V_G=10V,L=0.25mH,Rg=25 Ω

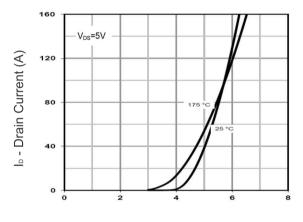


Typical Electrical and Thermal Characteristics



Vds Drain-Source Voltage (V)





Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

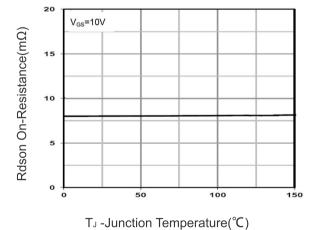
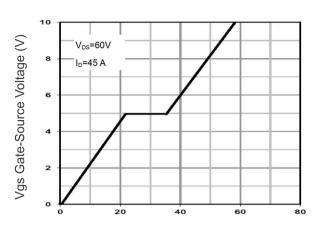


Figure 3 Rdson-Junction Temperature



Qg Gate Charge (nC)
Figure 4 Gate Charge

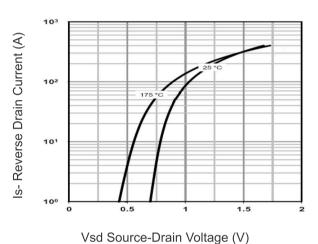
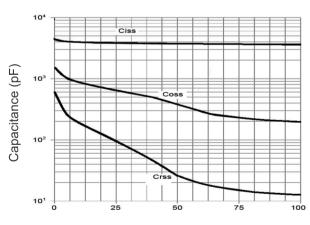


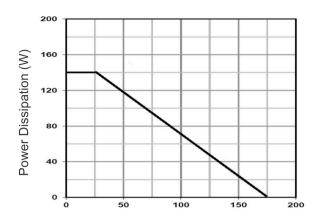
Figure 5 Source- Drain Diode Forward



Vds Drain-Source Voltage (V)

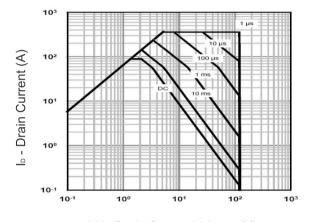
Figure 6 Capacitance vs Vds





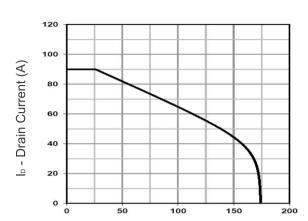
 $T_{\text{\tiny J}}$ -Junction Temperature(°C)

Figure 7 Power De-rating



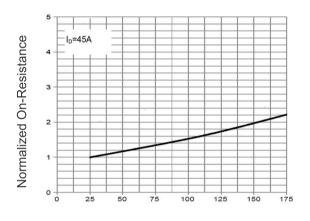
Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area



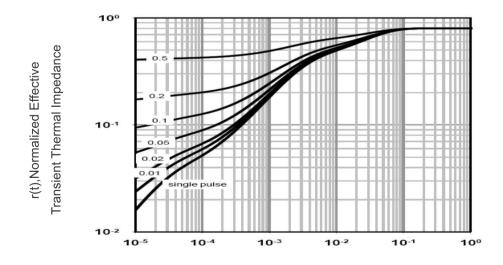
T_J -Junction Temperature(°C)

Figure 9 Current De-rating



 T_J -Junction Temperature(${}^{\circ}C$)

Figure 10 Rdson-Junction Temperature



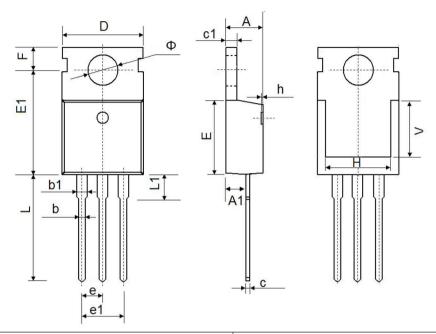
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	6.900 REF.		0.276 REF.		
Ф	3.400	3.800	0.134	0.150	





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